

C1206J225K4RACTU

Aliases (C1206J225K4RAC7800) SMD Comm X7R FO, Ceramic, 2.2 uF, 10%, 16 VDC, X7R, SMD, MLCC, Open Mode, Temperature Stable, 1206, 1.5 mm



Click here for the 3D model.

General Information	General Information		
Series	SMD Comm X7R FO		
Style	SMD Chip		
Description	SMD, MLCC, Open Mode, Temperature Stable		
Features	Open Mode, Temperature Stable		
RoHS	Yes		
Termination	Flexible Termination		
Marking	No		
AEC-Q200	No		
Typical Component Weight	25 mg		
Shelf Life	78 Weeks		
MSL	1		

	Specifications	
06	Capacitance	2.2 uF
3mm +/-0.4mm	Measurement Condition	1 kHz 1.0Vrms
5mm +/-0.35mm	Tolerance	10%
9mm +/-0.20mm	Voltage DC	16 VDC
imm MIN	Dielectric Withstanding Voltage	40 VDC
6mm +/-0.25mm	Temperature Range	-55/+125°C
	Temp. Coefficient	X7R
R, 180mm, Plastic Tape	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
000	Dissipation Factor	3.5% 1 kHz 1.0Vrms

Aging Rate

Insulation Resistance

 Chip Size
 1206

 L
 3.3mm +/-0.4mm

 W
 1.6mm +/-0.35mm

 T
 0.9mm +/-0.20mm

 S
 1.5mm MIN

 B
 0.6mm +/-0.25mm

Packaging Specifications

Dimensions

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	4000

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3% Loss/Decade Hour: Referee

Time is 1000 Hours

227.3 MOhms